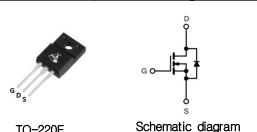
Sinai Power Technologies

www.sinai-power.com

N-channel Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	850			
R _{DS(on)} max. at 25°C (Ω)	V _{GS} =10V	1.2		
Q _g max. (nC)	70			
Q _{gs} (nC)	14			
Q _{gd} (nC)	21			
Configuration	single			



Features

- ID=10A(Vgs=10V)
- Ultra Low Gate Charge
- Improved dv/dt Capability
- 100% Avalanche Tested
- RoHS compliant

Applications

- Switching Mode Power Supplies (SMPS)
- PWM Motor Controls
- DC to DC Converters
- HID Lighting
- Bridge Circuits

ORDERING INFORMATION				
Device	SPC10N80G			
Device Package	TO-220F			
Marking	10N80G			

ABSOLUTE MAXIMUM RATINGS (Tc = 25°C, unless otherwise noted)						
Parameter	Symbol	Limit	Unit			
Drain to Source Voltage	V _{DSS}	800	V			
Continuous Drain Current (@T _C =25°C)		10 (1)	Α			
Continuous Drain Current (@T _C =100°C)	I _D	6.2 (1)	Α			
Drain current pulsed (2)	I _{DM}	40 (1)	Α			
Gate to Source Voltage	V _{GS}	30	V			
Single pulsed Avalanche Energy (3)	E _{AS}	384	mJ			
Peak diode Recovery dv/dt ⁽⁴⁾	dv/dt	6	V/ns			
Total power dissipation (@T _C =25°C)	-	48	W			
Derating Factor above 25°C	$ P_D$	0.384	W/ºC			
Operating Junction Temperature & Storage Temperature	T _{STG} , T _J	-55 to + 150	°C			
Maximum lead temperature for soldering purpose	TL	260	°C			
Mounting torque (5)		0.4~0.6	N.m			

Notes

- 1. Drain current is limited by maximum junction temperature.
- 2. Repetitive rating : pulse width limited by junction temperature.
- 3. L = 12mH, I_{AS} =8A, V_{DD} = 50V, R_{G} =25 Ω , Starting at T_{J} = 25 $^{\circ}$ C
- 4. $I_{SD} \le 10A$, di/dt = 100A/us, $V_{DD} \le BV_{DSS}$, Starting at $T_J = 25^{\circ}C$
- Mounting consideration for TO220 Fullpack:
 M3 screw plus flat washer is suggested, free of burr between devices and contact area,
 the devices are to be mounted to a hole not larger than 3.6mm in contact diameter (chamfer included).

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THERMAL CHARACTERISTICS					
Parameter	Symbol	Value	Unit		
Thermal resistance, Junction to case	R _{thjc}	2.4	°C/W		
Thermal resistance, Junction to ambient	R _{thja}	43	°C/W		

ELECTRICAL CHARACTERISTICS (Tc = 25°C unless otherwise specified)						
Parameter	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Off Characteristics						
Drain to source breakdown voltage	BV _{DSS}	V _{GS} =0V, I _D =250uA	800			V
Breakdown voltage temperature coefficient	ΔBV _{DSS} / ΔTJ	I _D =250uA, referenced to 25°C		0.42		V/°C
Drain to acure a lackage current		V _{DS} =800V, V _{GS} =0V			1	uA
Drain to source leakage current	I _{DSS}	V _{DS} =640V, T _C =125°C			50	uA
Gate to source leakage current, forward	I _{GSS}	V _{GS} =30V, V _{DS} =0V			100	nA
Gate to source leakage current, reverse	IGSS	V _{GS} =-30V, V _{DS} =0V			-100	nA
On Characteristics						
Gate threshold voltage	$V_{GS(TH)}$	V _{DS} =V _{GS} , I _D =250uA	2		4	V
Drain to source on state resistance	R _{DS(ON)}	V _{GS} =10V, I _D =5A		1.0	1.2	Ω
Forward Transconductance	Gfs	$V_{DS} = 30 \text{ V}, I_{D} = 5 \text{ A}$		8.5		S
Dynamic Characteristics						
Input capacitance	C _{iss}			1996		
Output capacitance	Coss	V _{GS} =0V, V _{DS} =25V, f=1MHz		136		pF
Reverse transfer capacitance	C _{rss}			27		
Turn on delay time	t _{d(on)}			16.2		
Rising time	tr	V_{DS} =400V, I_{D} =10A , R_{G} =25 Ω		39.6		ns
Turn off delay time	t _{d(off)}			62		115
Fall time	t _f			48		
Total gate charge	Q_g	V _{DS} =640V, V _{GS} =10V, I _D =10A		52		
Gate-source charge	Q _{gs}			13.5		nC
Gate-drain charge	Q_{gd}			21.1		

SOURCE TO DRAIN DIODE RATINGS CHARACTERISTICS							
Parameter	Symbol	Test conditions	Min.	Тур.	Max.	Unit	
Continuous source current	Is	Integral reverse p-n Junction L diode in the MOSFET			7	Α	
Pulsed source current	I _{SM}				28	Α	
Diode forward voltage drop.	V _{SD}	I _S =10A, V _{GS} =0V			1.2	V	
Reverse recovery time	T _{rr}	I _S =10A, V _{GS} =0V, dI _F /dt=100A/us		578	-	ns	
Reverse recovery Charge	Qrr			6.5		uC	



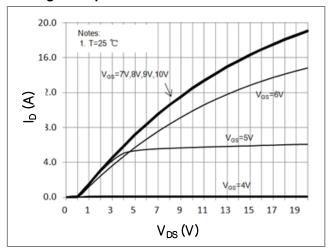


Fig3. Gate charge characteristics

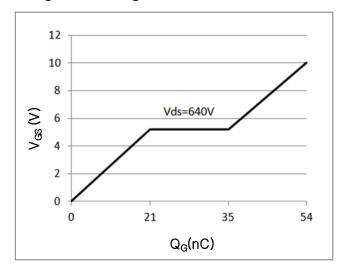


Fig 5. Rds(ON) vs junction temperature

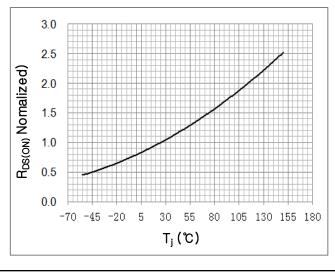


Fig2. Drain-source on-state resistance

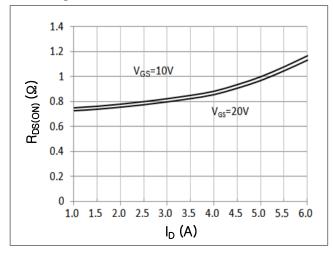


Fig 4. Capacitance Characteristics

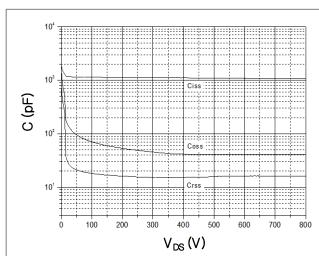


Fig 6. BVpss vs junction temperature

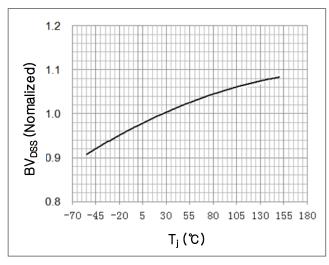




Fig 7. Safe operating area

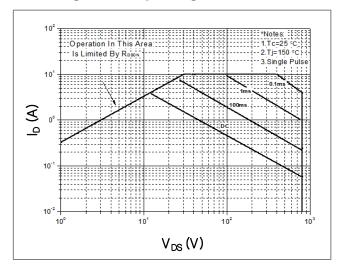


Fig 8. Transient thermal impedance

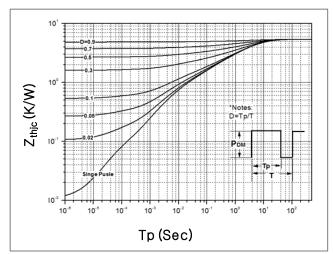


Fig 9. Forward characteristics of reverse diode

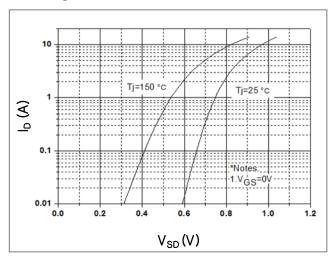
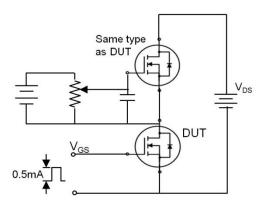


Fig 10. Gate charge test circuit & waveform



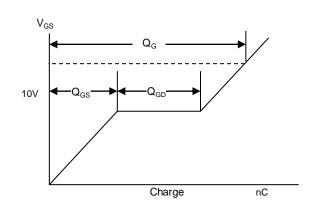




Fig 11. Switching time test circuit & waveform

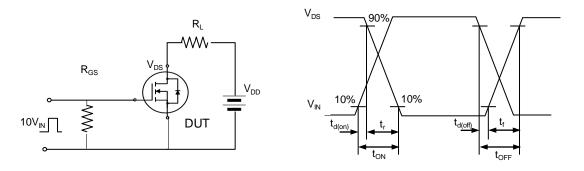


Fig 12. Unclamped Inductive switching test circuit & waveform

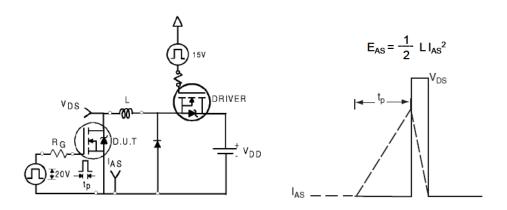
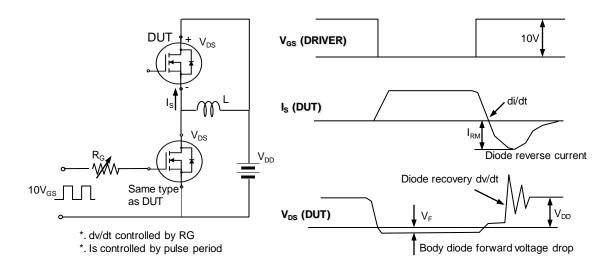


Fig 13. Peak diode recovery dv/dt test circuit & waveform



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